**Product data sheet** 

### 1. Product profile

### 1.1 General description

The BB172 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD323 (SC-76) very small SMD plastic package.

#### 1.2 Features and benefits

- Excellent linearity
- Very small SMD plastic package
- $C_{d(28V)} = 2.6 \text{ pF}; C_{d(1V)} \text{ to } C_{d(28V)} \text{ ratio} = 15$
- Low series resistance

### 1.3 Applications

Voltage Controlled Oscillators (VCO)

### 2. Pinning information

Table 1.	Pinning		
Pin	Description	Simplified outlin	e Symbol
1	cathode	[1]	JL.
2	anode	1 2	<del>     </del>
			sym008

<sup>[1]</sup> The marking bar indicates the cathode.

# 3. Ordering information

### 3.1 Package information

Table 2. Package information

Type number	Package	Package			
	Name	Description	Version		
BB172	SC-76	plastic surface-mounted package; 2 leads	SOD323		



#### VHF variable capacitance diode

### 3.2 Ordering information

Table 3. Ordering options

Type number	Orderable part number	Package	Packing method	Minimum order quantity
BB172	BB172X	SC-76	tape and reel	3000

### 4. Marking

Table 4. Marking

Type number	Marking code
BB172	4K

# 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{R}$	reverse voltage		-	32	V
		peak value in series with a 10 $k\Omega$ resistor	-	35	V
I <sub>F</sub>	forward current		-	20	mΑ
T <sub>stg</sub>	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

### 6. Characteristics

Table 6. Characteristics

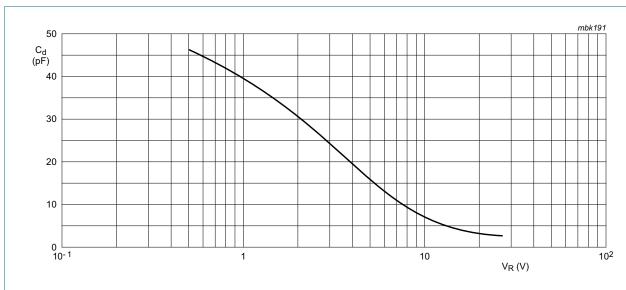
 $T_i = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>R</sub>	reverse current	$V_R = 30 \text{ V}$	[1]	-	-	10	nΑ
		$V_R = 30 \text{ V}; T_j = 85 ^{\circ}\text{C}$	[1]	-	-	200	nΑ
r <sub>s</sub>	diode series resistance	$f = 100 \text{ MHz}; C_d = 30 \text{ pF}$		-	0.65	8.0	Ω
C <sub>d</sub>	diode capacitance	f = 1 MHz	[2]				
		V <sub>R</sub> = 1 V		34.65	-	42.35	pF
		V <sub>R</sub> = 28 V		2.361	2.6	2.754	pF
$C_{d(1V)}\!/C_{d(2V)}$	diode capacitance ratio (1 V to 2 V)	f = 1 MHz		-	1.3	-	
$C_{d(1V)}/C_{d(28V)}$	diode capacitance ratio (1 V to 28 V)	f = 1 MHz		13.5	15	-	
$C_{d(25V)}/C_{d(28V)}$	diode capacitance ratio (25 V to 28 V)	f = 1 MHz		-	1.08	-	

<sup>[1]</sup> See Figure 2.

[2] See Figure 1 and Figure 3.

#### VHF variable capacitance diode



f = 1 MHz;  $T_i = 25 \,^{\circ}\text{C}$ .

Fig 1. Diode capacitance as a function of reverse voltage; typical values.

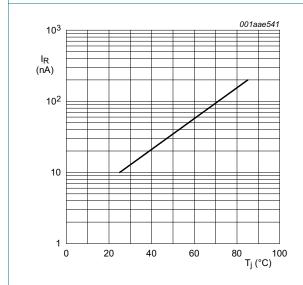
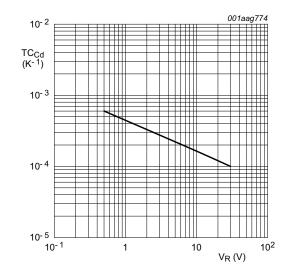


Fig 2. Reverse current as a function of junction temperature; maximum values.



 $T_i = 0$  °C to 85 °C.

Fig 3. Diode capacitance temperature coefficient as a function of reverse voltage; typical values.

### 7. Package outline

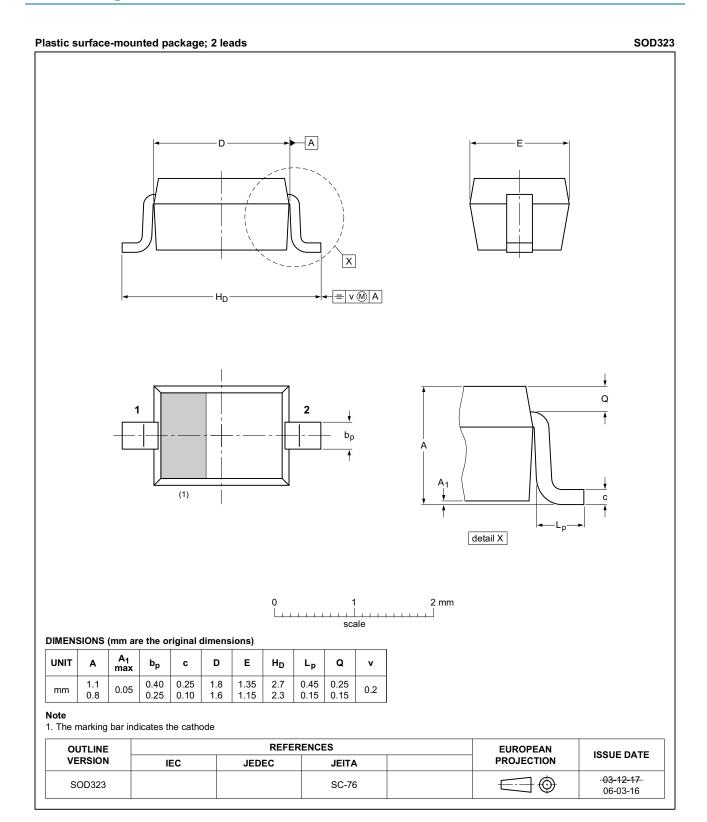


Fig 4. Package outline SOD323 (SC-76)

### VHF variable capacitance diode

### 8. Abbreviations

Table 7. Abbreviations

Acronym	Description
SMD	Surface Mounted Device
VHF	Very High Frequency

# 9. Revision history

#### Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB172 v.2	20131203	Product data sheet	-	BB172 v.1
Modifications	Section 3 on	page 1: additional ordering inf	ormation has been a	dded
BB172 v.1	20130325	Product data sheet	-	-

#### VHF variable capacitance diode

### 10. Legal information

#### 10.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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